



Product Change Notification

114053 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 114053 - 00
Change Title: Intel® SSD 750 Series (400GB, 800GB, 1.2TB, 1/2 Height PCIe 3.0 x4, 20nm, MLC) Single Pack,
Intel® SSD 750 Series (400GB, 800GB, 1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Single Pack,
Intel® SSD 750 Series (400GB, 1.2TB, 1/2 Height PCIe 3.0 x4, 20nm, MLC) Reseller 5 Pack,
Intel® SSD 750 Series (400GB, 1.2TB, 2.5in PCIe 3.0 x4, 20nm, MLC) Reseller 5 Pack,
PCN 114053-00, Product Design, Firmware Update
Date of Publication: September 03, 2015

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Sep 18, 2015
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Description of Change to the Customer:

The Intel® SSD 750 Series firmware version is being updated from 8EV10135 to 8EV10171. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
SSDPEDMW400G4R5	939234	H56036-301	H56037-300	H56036-302	H56037-301
SSDPEDMW012T4R5	939235	H56038-301	H56039-300	H56038-302	H56039-301
SSDPE2MW400G4R5	939434	H58392-202	H58397-201	H58392-203	H58397-202
SSDPE2MW012T4R5	939435	H58394-202	H58399-201	H58394-203	H58399-202
SSDPEDMW400G4X1	944775	H86952-300	H56037-300	H86952-301	H56037-301
SSDPEDMW800G4X1	944776	H87387-300	H84193-300	H87387-301	H84193-301
SSDPEDMW012T4X1	944777	H86953-300	H56039-300	H86953-301	H56039-301
SSDPE2MW400G4X1	944778	H86950-201	H58397-201	H86950-202	H58397-202
SSDPE2MW800G4X1	944779	H87388-201	H77909-201	H87388-202	H77909-202
SSDPE2MW012T4X1	944780	H86951-201	H58399-201	H86951-202	H58399-202

PCN Revision History:

Date of Revision:

September 3, 2015

Revision Number:

00

Reason:

Originally Published PCN